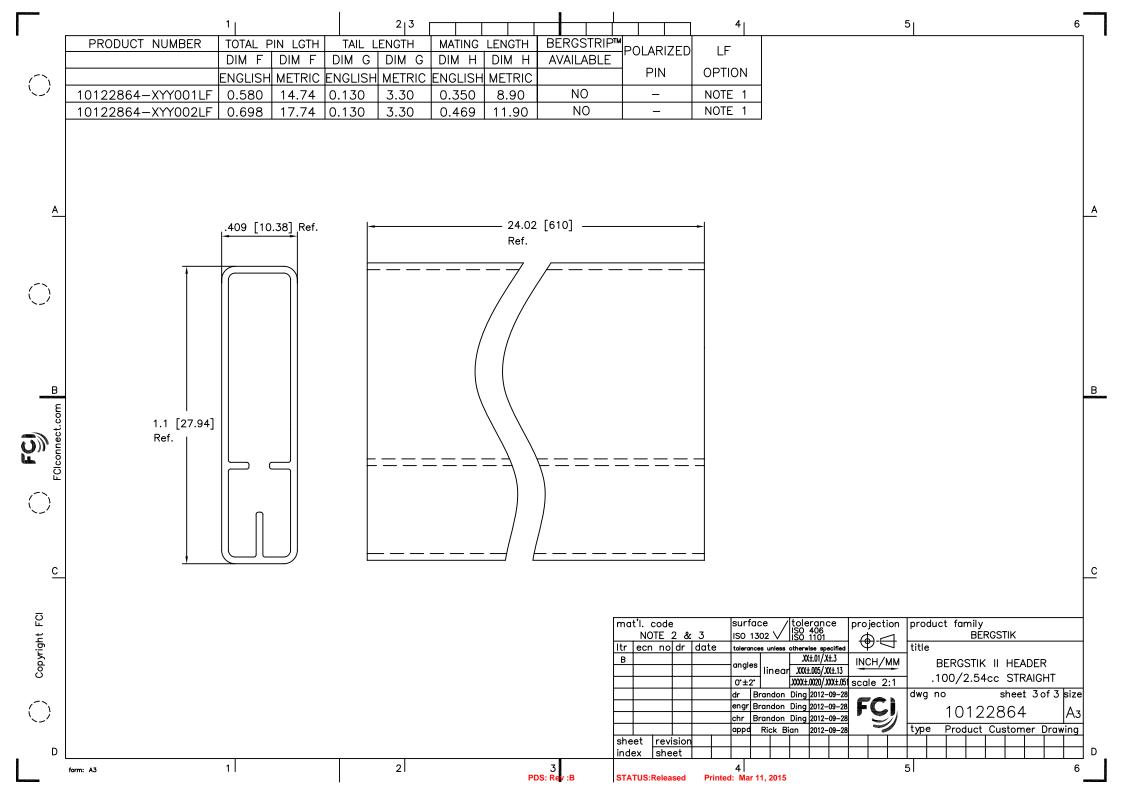


	1	2 3			4	5	6
•	PIN PLATING CODES:					1	<u> </u>
	10122864-1YYXXXLF 30u"/0.76u MIN GXT OVER 50u"/1.27u MIN Ni						
()	10122864-2YYXXXLF						
	10122864-4YYXXXLF   100u"/2.54u MIN Sn OVER 50u	10122864-4YYXXXLF   100u"/2.54u MIN Sn OVER 50u"/1.27u MIN Ni					
A					HOS BRONZE. PART IN RESTRAINED CON PIN TIPS NOT PLATED. TYP		A
<u></u>	NOTES						<del>-</del>
	1. PART NUMBER OPTIONS:			•	PIN RETENTION IN EITHER	R DIRECTION.	
	PIN PLATING CODES (SEE ABOVE)			7. MILITARY BERGSTI P/N XXXXX-XYY	IK HEADER '—MIL NOT AVAILABLE.		
$\bigcirc$	HIGH TEMPERATURE MATERIAL: PART NUMBERS WITH AND WITHOUT "H" WILL BE SUPPLIED WITH HIGH			8. ±.010/0.25 TOL APPLIES TO ALL "G" TAILS EXCEPT INDICATED PARTS ON TABLE WHERE +.010/0.25000/0.00 APPLIES.			
\/	TEMPERATURE PLASTIC.			9. NOTCH CONFIGUR	RATION WILL VARY PER VE	ENDOR'S DISCRETION.	
	NUMBER OF POSITIONS :  EVEN NUMBER OF POSITIONS FROM	2 (2X1) THROUGH 100 (2X36)		10. TAIL LENGTH (DI	M. G) TO BE ±.008/.0.20	0.	
	PACKAGED IN POLY BAGS.			11. THESE PRODUCTS MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.			
B E	EIGHT DIGIT PART NUMBERS FOLLOWEI IN TUBES. SEE SPECIFIC PART NUMBE EIGHT DIGIT PART NUMBERS FOLLOWEI IN GPAX FOR IBM ONLY. SEE SPECIFIC	RS FOR AVAILABILITY. BY A "G" ARE PACKAGED			IAS 100% TIN PLATING IN TESTED FOR WHISKER GRO	THE INTERFACE AND OWTH IN ALL INTERCONNECT	В
t.co	PART NUMBERS FOLLOWED BY A "C" ARE PACKAGED IN TUBES WITH A PICKUP CAP APPLIED.			13. THE OAL DON'T EXCEED 34.5mm			
F	PART NUMBERS FOLLOWED BY A "A" ARE PACKAGED IN TAPE AND REEL WITH A PICKUP CAP APPLIED.			14. INCREMENTS BY 0.1mm IN LENGTHS ONLY			
Clo	LEAD FREE:			15. FOR SPECIAL P	PACKAGING REQUEST PL	EASE CONTACT PRODUCT	
<i>(</i> `\	ADD "LF" SUFFIX AT THE END OF PA	RT NUMBER FOR LEAD FREE OPTION			AGER FOR AVAILABILITY		
	BODY MATERIAL:     BODY MATERIAL: MANUFACTURER'S OPTION     REINFORCED OR MINERAL FILLED LCP FLAN     COLOR: BLACK				DIMENSIONS: POSITION PER ROW POS. N X .100/2.54		
	THE PRODUCT WILL WITHSTAND EXPOSURE TO 260° C PEAK TEMPERATURE FOR 20 SE	CONDS IN					
<u>c</u>	WAVE SOLDER, INFRA—RED OR VAPOR PHAS						<u> </u> c
FO				mat'l. code	surface / tolerance ISO 1302 / ISO 406 ISO 1101	projection product family	
Copyright				NOTE 2 & 3 Itr ecn no dr date	tolerances unless otherwise specifie	ed title	
, do				В	angles   .XX±.01/.X±.3   linear   .XXX±.005/.XX±.13	T TOTAL DERGOIN II HEA	I
O					0°±2° .XXXX±.0020/.XXX±.0	.55 scale 2:1 .100/2.54cc STR	
$\langle  \rangle$					dr Brandon Ding 2012-09-2 engr Brandon Ding 2012-09-2		t.2 of 3 size
					chr Brandon Ding 2012-09-2 appd Rick Bian 2012-09-2		
(				sheet revision	-F-4 Mon Dian 2012-09-	- type i rodact ouston	S. Drawing
D   <b>I</b>	form: A3	2	.3	index  sheet	4	5	6 <b>I</b>
	11	<b>~</b> 1	3 PDS: Rev :B	STATUS:Released Prin	nted: Mar 11, 2015	<b>.</b>	<b>~</b> _



## **Mouser Electronics**

**Authorized Distributor** 

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FCI / Amphenol:

10122864-418002LF 10122864-418002CLF 10122864-418002ALF